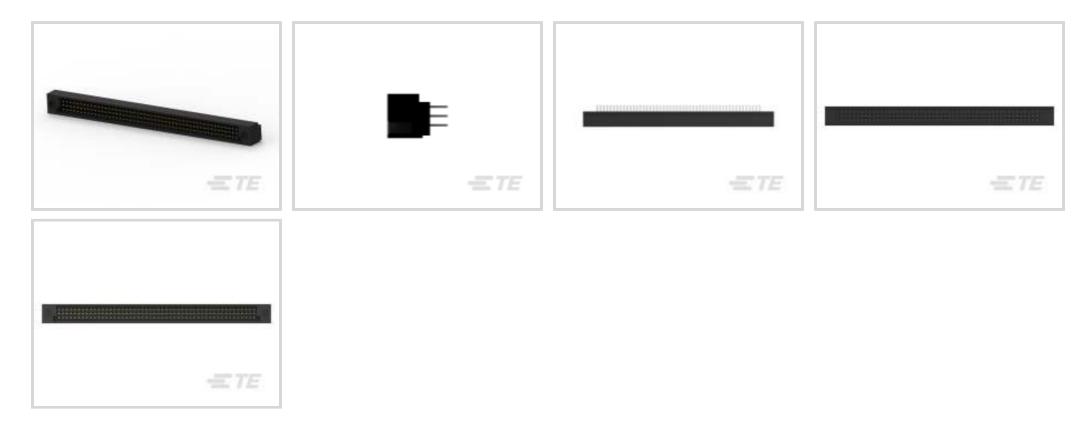
532433-7 **~** ACTIVE

AMP-HDI

TE Internal #: 532433-7 PCB Mount Header, Vertical, Board-to-Board, 150 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, Signal, Black

View on TE.com >





PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Number of Positions: 150

Number of Rows: 3

Features

E

Product Type Features

PCB Connector Assembly Type	PCB Mount Header
Connector System	Board-to-Board
Header Type	Fully Shrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Stackable	No
PCB Mount Orientation	Vertical
Number of Positions	150
Number of Rows	3
Electrical Characteristics	
Insulation Resistance	3 MΩ
Body Features	
Primary Product Color	Black

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PCB Mount Header, Vertical, Board-to-Board, 150 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, Signal, Black



Contact Features

Contact Mating Area Length	5.33 mm
Mating Square Post Dimension	.64 mm[.025 in]
Contact Layout	Matrix
Contact Shape & Form	Four Beam
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Phosphor Bronze
Contact Mating Area Plating Material	Gold
Contact Mating Area Plating Material Thickness	.76 μm[30 μin]
Contact Type	Pin
Contact Current Rating (Max)	3 A
Termination Features	
Square Termination Post & Tail Dimension	.64 mm[.025 in]
Termination Post & Tail Length	4.83 mm[.19 in]
Termination Method to Printed Circuit Board	Through Hole - Solder
Termination Method to Printed Circuit Board Mechanical Attachment	Through Hole - Solder

Mating Alignment Type	Keyed
PCB Mount Retention	Without
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount
Housing Features	
Centerline (Pitch)	2.54 mm[.1 in]
Housing Material	Thermoplastic
Dimensions	
Connector Height	11.73 mm[.46 in]
PCB Thickness (Recommended)	1.57 mm[.76 in]
Usage Conditions	
Housing Temperature Rating	High
Operating Temperature Range	-65 – 125 °C[-85 – 257 °F]
Operation/Application	
Solder Process Feature	Board Standoff

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PCB Mount Header, Vertical, Board-to-Board, 150 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, Signal, Black



Circuit Application	Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	4
Packaging Type	Tube
EU RoHS Directive 2011/65/EU	Not Compliant
EU RoHS Directive 2011/65/EU	Not Compliant
EU ELV Directive 2000/53/EC	Compliant with Exemptions
China Rolls 2 Directive MILT Order No. 22, 2014	
China RoHS 2 Directive MIIT Order No 32, 2016	Restricted Materials Above Threshold

Halogen Content

Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free

Not lead free process capable

Solder Process Capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts

PCB Mount Header, Vertical, Board-to-Board, 150 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, Signal, Black





Customers Also Bought



30 NOVO DUAL 30DP, LEAD FR	EE
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Documents

Product Drawings HDI PIN ASSY 3 ROW 150 POS

English

CAD Files

3D PDF

3D

Customer View Model ENG_CVM_CVM_532433-7_T.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_532433-7_T.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_532433-7_T.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use

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PCB Mount Header, Vertical, Board-to-Board, 150 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, Signal, Black



Datasheets & Catalog Pages

1-1773957-5_AMP_HDI_BTB_CONNECTORS_EN

English

Product Specifications

Application Specification

English

Instruction Sheets

Instruction Sheet (U.S.)

English

Agency Approvals Agency Approval Document

English